H510M S2H V3 H510M H V2 H510M S2 V2

User's Manual Rev. 2001



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- For detailed product information, carefully read the User's Manual.
- For quick set-up of the product, refer to the Quick Installation Guide on GIGABYTE's website.

https://download.gigabyte.com/FileList/Manual/mb_manual_installation-guide_103.pdf?m=sw

For product-related information, check on our website at: https://www.gigabyte.com

Identifying Your Motherboard Revision

The revision number on your motherboard looks like this: "REV: X.X." For example, "REV: 1.0" means the revision of the motherboard is 1.0. Check your motherboard revision before updating motherboard BIOS, drivers, or when looking for technical information.

Example:

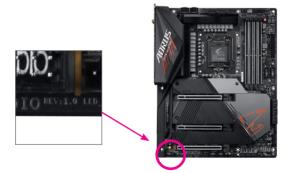
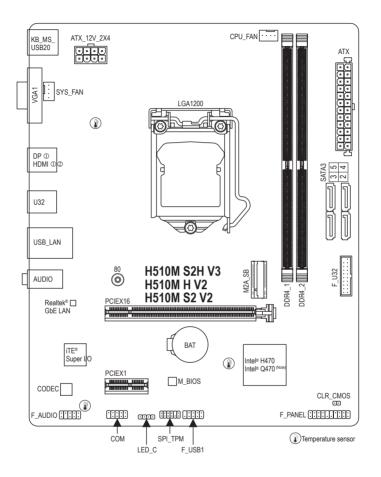


Table of Contents

Chapter 1	Produ	uct Introduction	4
	1-1	Motherboard Layout	4
Chapter 2	Hard	ware Installation	5
	2-1	Installation Precautions	5
	2-2	Product Specifications	6
	2-3	Installing the CPU and CPU Cooler	9
	2-4	Installing the Memory	10
	2-5	Installing an Expansion Card	11
	2-6	Back Panel Connectors	12
	2-7	Internal Connectors	14
Chapter 3	BIOS	Setup	23
Chapter 4	Instal	ling the Operating System and Drivers	25
	4-1	Operating System Installation	25
	4-2	Drivers Installation	26
Chapter 5	Appe	ndix	27
	5-1	Configuring a RAID Set	
	Regul	atory Notices	28
	Conta	ct Us	29

Chapter 1 Product Introduction

1-1 Motherboard Layout



① Only for H510M S2H V3.

- ② Only for H510M H V2.
- (Note) Only for PCB rev. 2.0 or later.

Chapter 2 Hardware Installation

2-1 Installation Precautions

The motherboard contains numerous delicate electronic circuits and components which can become damaged as a result of electrostatic discharge (ESD). Prior to installation, carefully read the user's manual and follow these procedures:

- Prior to installation, make sure the chassis is suitable for the motherboard.
- Prior to installation, do not remove or break motherboard S/N (Serial Number) sticker or warranty sticker provided by your dealer. These stickers are required for warranty validation.
- Always remove the AC power by unplugging the power cord from the power outlet before installing or removing the motherboard or other hardware components.
- When connecting hardware components to the internal connectors on the motherboard, make sure they are connected tightly and securely.
- When handling the motherboard, avoid touching any metal leads or connectors.
- It is best to wear an electrostatic discharge (ESD) wrist strap when handling electronic components such as a motherboard, CPU or memory. If you do not have an ESD wrist strap, keep your hands dry and first touch a metal object to eliminate static electricity.
- Prior to installing the motherboard, please have it on top of an antistatic pad or within an electrostatic shielding container.
- Before connecting or unplugging the power supply cable from the motherboard, make sure the power supply has been turned off.
- Before turning on the power, make sure the power supply voltage has been set according to the local voltage standard.
- Before using the product, please verify that all cables and power connectors of your hardware components are connected.
- To prevent damage to the motherboard, do not allow screws to come in contact with the motherboard circuit or its components.
- Make sure there are no leftover screws or metal components placed on the motherboard or within the computer casing.
- Do not place the computer system on an uneven surface.
- Do not place the computer system in a high-temperature or wet environment.
- Turning on the computer power during the installation process can lead to damage to system components as well as physical harm to the user.
- If you are uncertain about any installation steps or have a problem related to the use of the product, please consult a certified computer technician.
- If you use an adapter, extension power cable, or power strip, ensure to consult with its installation and/or grounding instructions.

2-2 Product Specifications

CPU •	 LGA1200 package: 11th Generation Intel[®] Core[™] i9 processors/Intel[®] Core[™] i7 processors/ Intel[®] Core[™] i5 processors 10th Generation Intel[®] Core[™] i9 processors/Intel[®] Core[™] i7 processors/Intel[®] Core[™] i5 processors/Intel[®] Core[™] i3 processors/Intel[®] Pentium[®] processors/ Intel[®] Celeron[®] processors (Go to GIGABYTE's website for the latest CPU support list.) L3 cache varies with CPU
Chipset	Intel® H470 Express Chipset Intel® Q470 Express Chipset ^(Nole)
Memory +	11th Generation Intel® Core™ i9/i7/i5 Processors: - Support for DDR4 3200/3000/2933/2666/2400/2133 MT/s memory modules
•	10th Generation Intel [®] Core [™] i9/i7 Processors: - Support for DDR4 2933/2666/2400/2133 MT/s memory modules
•	10th Generation Intel [®] Core [™] i5/i3/Pentium [®] /Celeron [®] Processors:
	 Support for DDR4 2666/2400/2133 MT/s memory modules
•	2 x DDR4 DIMM sockets supporting up to 64 GB (32 GB single DIMM capacity) of system memory
•	Dual channel memory architecture
•	Support for ECC Un-buffered DIMM 1Rx8/2Rx8 memory modules (operate in non-ECC mode)
•	Support for non-ECC Un-buffered DIMM 1Rx8/2Rx8/1Rx16 memory modules Support for Extreme Memory Profile (XMP) memory modules (The CPU and memory configuration may affect the supported memory types, data rate (speed), and number of DRAM modules, please refer to "Memory Support List" on GIGABYTE's website for more information.)
Onboard • Graphics	Integrated Graphics Processor-Intel® HD Graphics support: - 1 x DisplayPort, supporting a maximum resolution of 4096x2304@60 Hz ①
	 * Support for DisplayPort 1.2 version and HDCP 2.3. 1 x HDMI port, supporting a maximum resolution of 4096x2160@30 Hz ^① ^② * Support for HDMI 1.4 version and HDCP 2.3.
	 1 x D-Sub port, supporting a maximum resolution of 1920x1200@60 Hz * The D-Sub port is only available with the 10th Generation processors.
	- Support for up to 3 displays at the same time ①
	* Only available with the 10th Generation processors.
Audio	(Graphics specifications may vary depending on CPU support.)
Audio •	Realtek® Audio CODEC
•	High Definition Audio
•	2/4/5.1/7.1-channel * You can change the functionality of an audio jack using the audio software. To configure 7.1-channel audio, access the audio software for audio settings.
	Realtek® GbE LAN chip (1 Gbps/100 Mbps/10 Mbps)

① Only for H510M S2H V3.

- ② Only for H510M H V2.
- (Note) Only for PCB rev. 2.0 or later.

Expansion Slots	 CPU: 1 x PCI Express x16 slot, supporting PCIe 3.0 and running at x16 Chipset:
	 1 x PCI Express x1 slot, supporting PCIe 3.0 and running at x1
Storage Interface	 1 x M.2 connector (Socket 3, M key, type 2280 SATA and PCIe 3.0 x4/x2 SSD support) 4 x SATA 6Gb/s connectors
	 RAID 0 and RAID 1 support for NVMe SSD storage devices Supported only with an additional PCIe to M.2 NVMe SSD adapter card and Intel® NVMe SSD.
	 RAID 0, RAID 1, RAID5, and RAID 10 support for SATA storage devices
USB	 Chipset: 4 x USB 3.2 Gen 1 ports (2 ports on the back panel, 2 ports available through the internal USB header) 6 x USB 2.0/1.1 ports (4 ports on the back panel, 2 ports available through the internal USB header)
Internal	1 x 24-pin ATX main power connector
Connectors	1 x 8-pin ATX 12V power connector
	 1 x CPU fan header
	 1 x system fan header
	 1 x RGB LED strip header
	 1 x M.2 Socket 3 connector
	4 x SATA 6Gb/s connectors
	 1 x front panel header
	 1 x front panel audio header
	 1 x USB 3.2 Gen 1 header
	 1 x USB 2.0/1.1 header
	 1 x Trusted Platform Module header (For the GC-TPM2.0 SPI/GC-TPM2.0 SPI 2.0/
	GC-TPM2.0 SPI V2 module only)
	1 x serial port header
	1 x Clear CMOS jumper
Back Panel	 1 x PS/2 keyboard/mouse port
Connectors	1 x D-Sub port
	• 1 x DisplayPort ①
	 ▲ 1 x HDMI port ①②
	2 x USB 3.2 Gen 1 ports
	 4 x USB 2.0/1.1 ports
	 1 x RJ-45 port
	3 x audio jacks
I/O Controller	iTE® I/O Controller Chip

① Only for H510M S2H V3.

② Only for H510M H V2.

Hardware	Voltage detection
Monitor	Temperature detection
	Fan speed detection
	Fan fail warning
	Fan speed control
	* Whether the fan speed control function is supported will depend on the fan you install.
BIOS	1 x 128 Mbit flash
	Use of licensed AMI UEFI BIOS
	 PnP 1.0a, DMI 2.7, WfM 2.0, SM BIOS 2.7, ACPI 5.0
Unique Features	Support for APP Center
	* Available applications in APP Center may vary by motherboard model. Supported
	functions of each application may also vary depending on motherboard specifications.
	- @BIOS
	- Ambient LED
	- EasyTune
	- Smart Backup
	- System Information Viewer
	Support for Q-Flash
Bundled	 Norton[®] Internet Security (OEM version)
Software	LAN bandwidth management software
Operating	Support for Windows 11 64-bit
System	Support for Windows 10 64-bit
Form Factor	Micro ATX Form Factor; 22.6cm x 18.5cm

* GIGABYTE reserves the right to make any changes to the product specifications and product-related information without prior notice.

Please visit the SERVICE/SUPPORT/Utility page on GIGABYTE's website to download the latest version of apps. https://www.gigabyte.com/Support/Utility/Motherboard?m=ut

2-3 Installing the CPU and CPU Cooler

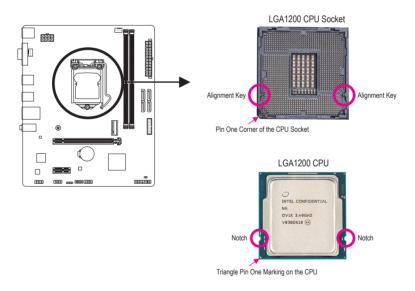


Read the following guidelines before you begin to install the CPU:

- Make sure that the motherboard supports the CPU.
 - (Go to GIGABYTE's website for the latest CPU support list.)
- Always turn off the computer and unplug the power cord from the power outlet before installing the CPU to prevent hardware damage.
- Locate the pin one of the CPU. The CPU cannot be inserted if oriented incorrectly. (Or you may locate the notches on both sides of the CPU and alignment keys on the CPU socket.)
- · Apply an even and thin layer of thermal grease on the surface of the CPU.
- Do not turn on the computer if the CPU cooler is not installed, otherwise overheating and damage of the CPU may occur.
- Set the CPU host frequency in accordance with the CPU specifications. It is not recommended
 that the system bus frequency be set beyond hardware specifications since it does not meet the
 standard requirements for the peripherals. If you wish to set the frequency beyond the standard
 specifications, please do so according to your hardware specifications including the CPU, graphics
 card, memory, hard drive, etc.

Installing the CPU

Note the alignment keys on the motherboard CPU socket and the notches on the CPU.



Do not remove the CPU socket cover before inserting the CPU. It may pop off from the load plate automatically after you insert the CPU and close the load plate.

Please visit GIGABYTE's website for details on hardware installation. <u>https://www.gigabyte.com/WebPage/210/quick-guide.html?m=sw</u>

2-4 Installing the Memory



Read the following guidelines before you begin to install the memory:

- Make sure that the motherboard supports the memory. It is recommended that memory of the same capacity, brand, speed, and chips be used. (Go to GIGABYTE's website for the latest supported memory speeds and memory modules.)
- Always turn off the computer and unplug the power cord from the power outlet before installing the memory to prevent hardware damage.
- Memory modules have a foolproof design. A memory module can be installed in only one direction. If you are unable to insert the memory, switch the direction.

Dual Channel Memory Configuration

This motherboard provides two memory sockets and supports Dual Channel Technology. After the memory is installed, the BIOS will automatically detect the specifications and capacity of the memory. Enabling Dual Channel memory mode will double the original memory bandwidth.

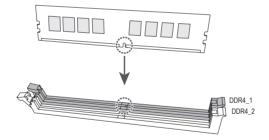
The two memory sockets are divided into two channels and each channel has one memory socket as following:

➤ Channel A: DDR4_1

➡ Channel B: DDR4_2

Due to CPU limitations, read the following guidelines before installing the memory in Dual Channel mode.

- 1. Dual Channel mode cannot be enabled if only one memory module is installed.
- 2. When enabling Dual Channel mode with two memory modules, it is recommended that memory of the same capacity, brand, speed, and chips be used.



2-5 Installing an Expansion Card

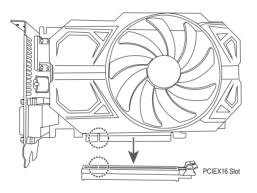


Read the following guidelines before you begin to install an expansion card:

- Make sure the motherboard supports the expansion card. Carefully read the manual that came with your expansion card.
- Always turn off the computer and unplug the power cord from the power outlet before installing an
 expansion card to prevent hardware damage.

Follow the steps below to correctly install your expansion card in the expansion slot.

- 1. Locate an expansion slot that supports your card. Remove the metal slot cover from the chassis back panel.
- 2. Align the card with the slot, and press down on the card until it is fully seated in the slot.
- 3. Make sure that the expansion card is fully seated in its slot.
- 4. Secure the card's metal bracket to the chassis back panel with a screw.
- 5. After installing all expansion cards, replace the chassis cover(s).
- 6. Turn on your computer. If necessary, go to BIOS Setup to make any required BIOS changes for your expansion card(s).
- 7. Install the driver provided with the expansion card in your operating system.



2-6 Back Panel Connectors



USB 2.0/1.1 Port

The USB port supports the USB 2.0/1.1 specification. Use this port for USB devices.

PS/2 Keyboard/Mouse Port

Use this port to connect a PS/2 mouse or keyboard.

D-Sub Port

The D-Sub port supports a 15-pin D-Sub connector and supports a maximum resolution of 1920x1200@60 Hz (the actual resolutions supported depend on the monitor being used). Connect a monitor that supports D-Sub connection to this port.

DisplayPort ①

DisplayPort delivers high quality digital imaging and audio, supporting bi-directional audio transmission. DisplayPort can support the HDCP 2.3 content protection mechanism. You can use this port to connect your DisplayPort-supported monitor. Note: The DisplayPort Technology can support a maximum resolution of 4096x2304@60 Hz but the actual resolutions supported depend on the monitor being used.

HDMI Port ①②

The HDMI port is HDCP 2.3 compliant and supports Dolby TrueHD and DTS HD MIGH-DEFINITION MULTIMEDIA INTERFACE TAUGIO formats. It also supports up to 192KHz/16bit 7.1-channel LPCM audio output. You can use this port to connect your HDMI-supported monitor. The maximum supported resolution is 4096x2160@30 Hz, but the actual resolutions supported are dependent on the monitor being used.



After installing the DisplayPort/HDMI device, make sure to set the default sound playback device to bisplayPort/HDMI. (The item name may differ depending on your operating system.)

Triple-Display Configurations for the Onboard Graphics ①

Triple-display configurations (only available with the 10th generation processors) are supported after you install motherboard drivers in OS. Only dual-display configurations are supported during the BIOS Setup or POST process.

USB 3.2 Gen 1 Port

The USB 3.2 Gen 1 port supports the USB 3.2 Gen 1 specification and is compatible to the USB 2.0 specification. Use this port for USB devices.

Only for H510M S2H V3.

② Only for H510M H V2.

RJ-45 | AN Port

The Gigabit Ethernet LAN port provides Internet connection at up to 1 Gbps data rate. The following describes the states of the LAN port LEDs.

Speed LED Activity LED	Speed LED:		Activity LED:	
	State	Description	State	Description
	Orange	1 Gbps data rate	Blinking	Data transmission or receiving is occurring
	Green	100 Mbps data rate	Off	No data transmission or receiving is occurring
LAN Port	Off	10 Mbps data rate		

Line In/Rear Speaker Out (Blue)

The line in jack. Use this audio jack for line in devices such as an optical drive, walkman, etc.

Line Out/Front Speaker Out (Green)

The line out jack.

Mic In/Center/Subwoofer Speaker Out (Pink)

The Mic in jack.

Audio Jack Configurations:

	Jack	Headphone/ 2-channel	4-channel	5.1-channel	7.1-channel
0	Line In/Rear Speaker Out		~	~	~
0	Line Out/Front Speaker Out	~	~	*	~
0	Mic In/ Center/Subwoofer Speaker Out			~	~
	Front Panel Line Out/Side Speaker Out				~



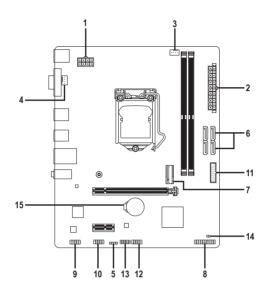
You can change the functionality of an audio jack using the audio software. To configure 7.1-channel audio, access the audio software for audio settings.

Please visit GIGABYTE's website for details on configuring the audio software. Ċ https://www.gigabyte.com/WebPage/697/realtek897-audio.html



- · When removing the cable connected to a back panel connector, first remove the cable from your device and then remove it from the motherboard.
- When removing the cable, pull it straight out from the connector. Do not rock it side to side to prevent an electrical short inside the cable connector.

2-7 Internal Connectors



1)	ATX_12V_2X4	9)	F_AUDIO
2)	ATX	10)	СОМ
3)	CPU_FAN	11)	F_U32
4)	SYS_FAN	12)	F_USB1
5)	LED_C	13)	SPI_TPM
6)	SATA3 2/3/4/5	14)	CLR_CMOS
7)	M2A_SB	15)	BAT
8)	F_PANEL		



Read the following guidelines before connecting external devices:

- · First make sure your devices are compliant with the connectors you wish to connect.
- Before installing the devices, be sure to turn off the devices and your computer. Unplug the power cord from the power outlet to prevent damage to the devices.
- After installing the device and before turning on the computer, make sure the device cable has been securely attached to the connector on the motherboard.

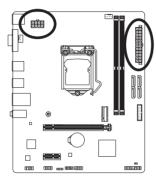
1/2) ATX_12V_2X4/ATX (2x4 12V Power Connector and 2x12 Main Power Connector)

With the use of the power connector, the power supply can supply enough stable power to all the components on the motherboard. Before connecting the power connector, first make sure the power supply is turned off and all devices are properly installed. The power connector possesses a foolproof design. Connect the power supply cable to the power connector in the correct orientation.

The 12V power connector mainly supplies power to the CPU. If the 12V power connector is not connected, the computer will not start.

C.

To meet expansion requirements, it is recommended that a power supply that can withstand high power consumption be used (500W or greater). If a power supply is used that does not provide the required power, the result can lead to an unstable or unbootable system.

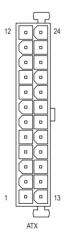




ATV

ATX_12V_2X4:			
Pin No.	Definition		
1	GND (Only for 2x4-pin 12V)		
2	GND (Only for 2x4-pin 12V)		
3	GND		
4	GND		
5	+12V (Only for 2x4-pin 12V)		
6	+12V (Only for 2x4-pin 12V)		
7	+12V		
8	+12V		

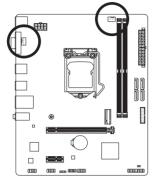
TV 401/ 0V4

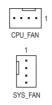


AIX:			
Pin No.	Definition	Pin No.	Definition
1	3.3V	13	3.3V
2	3.3V	14	-12V
3	GND	15	GND
4	+5V	16	PS_ON (soft On/Off)
5	GND	17	GND
6	+5V	18	GND
7	GND	19	GND
8	Power Good	20	NC
9	5VSB (stand by +5V)	21	+5V
10	+12V	22	+5V
11	+12V (Only for 2x12-pin ATX)	23	+5V (Only for 2x12-pin ATX)
12	3.3V (Only for 2x12-pin ATX)	24	GND (Only for 2x12-pin ATX)

3/4) CPU_FAN/SYS_FAN (Fan Headers)

All fan headers on this motherboard are 4-pin. Most fan headers possess a foolproof insertion design. When connecting a fan cable, be sure to connect it in the correct orientation (the black connector wire is the ground wire). The speed control function requires the use of a fan with fan speed control design. For optimum heat dissipation, it is recommended that a system fan be installed inside the chassis.





Pin No.	Definition
1	GND
2	Voltage Speed Control
3	Sense
4	PWM Speed Control

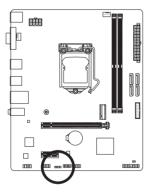
Connector	CPU_FAN	SYS_FAN
Maximum Current	2A	2A
Maximum Power	24W	24W



- Be sure to connect fan cables to the fan headers to prevent your CPU and system from overheating. Overheating may result in damage to the CPU or the system may hang.
- These fan headers are not configuration jumper blocks. Do not place a jumper cap on the headers.

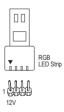
5) LED_C (RGB LED Strip Header)

The header can be used to connect a standard 5050 RGB LED strip (12V/G/R/B), with maximum power rating of 2A (12V) and maximum length of 2m.



1

Pin No.	Definition
1	12V
2	G
3	R
4	В



Connect your RGB LED strip to the header. The power pin (marked with a triangle on the plug) of the LED strip must be connected to Pin 1 (12V) of this header. Incorrect connection may lead to the damage of the LED strip.



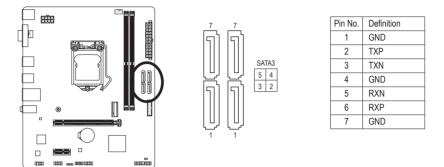
. For how to turn on/off the lights of the LED strip, please navigate to the "Unique Features" page of GIGABYTE's website.



Before installing or removing the devices, be sure to turn off the devices and your computer. Unplug the power cord from the power outlet to prevent damage to the devices.

6) SATA3 2/3/4/5 (SATA 6Gb/s Connectors)

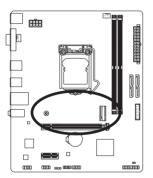
The SATA connectors conform to SATA 6Gb/s standard and are compatible with SATA 3Gb/s and SATA 1.5Gb/s standard. Each SATA connector supports a single SATA device. The Intel® Chipset supports RAID 0, RAID 1, RAID 5, and RAID 10. Please navigate to the "Configuring a RAID Set" page of GIGABYTE's website for instructions on configuring a RAID array.



To enable hot-plugging for the SATA ports, please visit the "BIOS Setup," "Settings\IO Ports\SATA And RST Configuration," webpage of GIGABYTE's website for more information.

7) M2A_SB (M.2 Socket 3 Connector)

The M.2 connector supports M.2 SATA SSDs or M.2 PCIe SSDs and support RAID configuration. Please note that an M.2 PCIe SSD cannot be used to create a RAID set with a SATA hard drive. Please navigate to the "Configuring a RAID Set" page of GIGABYTE's website for instructions on configuring a RAID array.





e,

Follow the steps below to correctly install an M.2 SSD in the M.2 connector.

Step 1:

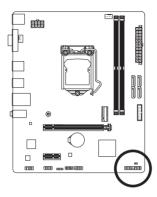
Pull the clip's tab up and out of the mounting hole. Slide the M.2 SSD into the connector at an angle.

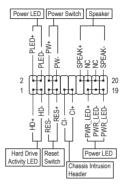
Step 2:

Press the M.2 SSD down and then secure it by pressing the clip's tab into the mounting hole.

8) F_PANEL (Front Panel Header)

Connect the power switch, reset switch, speaker, chassis intrusion switch/sensor and system status indicator on the chassis to this header according to the pin assignments below. Note the positive and negative pins before connecting the cables.





• PLED/PWR_LED (Power LED):

System Status	LED	C
S0	On	is
S3/S4/S5	Off	S

Connects to the power status indicator on the chassis front panel. The LED s on when the system is operating. The LED is off when the system is in S3/ S4 sleep state or powered off (S5).

• **PW** (Power Switch):

Connects to the power switch on the chassis front panel. You may configure the way to turn off your system using the power switch (please navigate to the "BIOS Setup" page of GIGABYTE's website and search for "Settings\Platform Power" for more information).

• SPEAK (Speaker):

Connects to the speaker on the chassis front panel. The system reports system startup status by issuing a beep code. One single short beep will be heard if no problem is detected at system startup.

 HD (Hard Drive Activity LED): Connects to the hard drive activity LED on the chassis front panel. The LED is on when the hard drive is reading or writing data.

RES (Reset Switch):

Connects to the reset switch on the chassis front panel. Press the reset switch to restart the computer if the computer freezes and fails to perform a normal restart.

- CI (Chassis Intrusion Header): Connects to the chassis intrusion switch/sensor on the chassis that can detect if the chassis cover has been removed. This function requires a chassis with a chassis intrusion switch/sensor.
- NC: No connection.

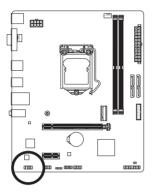


The front panel design may differ by chassis. A front panel module mainly consists of power switch, reset switch, power LED, hard drive activity LED, speaker and etc. When connecting your chassis front panel module to this header, make sure the wire assignments and the pin assignments are matched correctly.

9) F_AUDIO (Front Panel Audio Header)

The front panel audio header supports High Definition audio (HD). You may connect your chassis front panel audio module to this header. Make sure the wire assignments of the module connector match the pin assignments of the motherboard header. Incorrect connection between the module connector and the motherboard header will make the device unable to work or even damage it.

9 • • • • • • 1 10 • • • • • 2

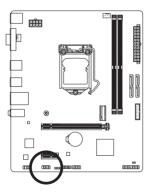


Pin No.	Definition
1	MIC L
2	GND
3	MIC R
4	NC
5	Head Phone R
6	MIC Detection
7	SENSE_SEND
8	No Pin
9	Head Phone L
10	Head Phone Detection
	1 2 3 4 5 6 7 8 9

Some chassis provide a front panel audio module that has separated connectors on each wire instead of a single plug. For information about connecting the front panel audio module that has different wire assignments, please contact the chassis manufacturer.

10) COM (Serial Port Header)

The COM header can provide one serial port via an optional COM port cable. For purchasing the optional COM port cable, please contact the local dealer.

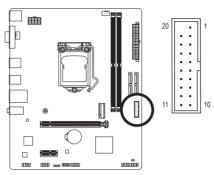


9 • • • • • 1 10 • • • • 2

Pin No.	Definition
1	NDCD-
2	NSIN
3	NSOUT
4	NDTR-
5	GND
6	NDSR-
7	NRTS-
8	NCTS-
9	NRI-
10	No Pin

11) F_U32 (USB 3.2 Gen 1 Header)

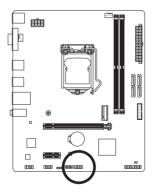
The header conforms to USB 3.2 Gen 1 and USB 2.0 specification and can provide two USB ports. For purchasing the optional 3.5" front panel that provides two USB 3.2 Gen 1 ports, please contact the local dealer.



Pin No.	Definition	Pin No.	Definition
1	VBUS	11	D2+
2	SSRX1-	12	D2-
3	SSRX1+	13	GND
4	GND	14	SSTX2+
5	SSTX1-	15	SSTX2-
6	SSTX1+	16	GND
7	GND	17	SSRX2+
8	D1-	18	SSRX2-
9	D1+	19	VBUS
10	NC	20	No Pin

12) F_USB1 (USB 2.0/1.1 Header)

The header conforms to USB 2.0/1.1 specification. Each USB header can provide two USB ports via an optional USB bracket. For purchasing the optional USB bracket, please contact the local dealer.



9	\square				•	1
10	ŀ	•	•	ŀ.	ŀ	2
	-	-	-	-	-	

Pin No.	Definition
1	Power (5V)
2	Power (5V)
3	USB DX-
4	USB DY-
5	USB DX+
6	USB DY+
7	GND
8	GND
9	No Pin
10	NC

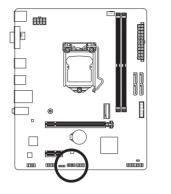


Prior to installing the USB bracket, be sure to turn off your computer and unplug the power cord from the power outlet to prevent damage to the USB bracket.

13) SPI_TPM (Trusted Platform Module Header)

You may connect an SPI TPM (Trusted Platform Module) to this header.

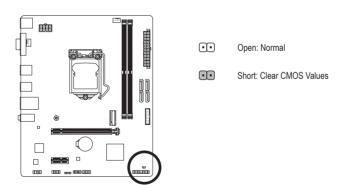
11 12



Pin No.	Definition
1	Data Output
2	Power (3.3V)
3	No Pin
4	NC
5	Data Input
6	CLK
7	Chip Select
8	GND
9	IRQ
10	NC
11	NC
12	RST

14) CLR_CMOS (Clear CMOS Jumper)

Use this jumper to clear the BIOS configuration and reset the CMOS values to factory defaults. To clear the CMOS values, use a metal object like a screwdriver to touch the two pins for a few seconds.

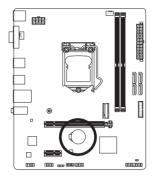




- Always turn off your computer and unplug the power cord from the power outlet before clearing the CMOS values.
- After system restart, go to BIOS Setup to load factory defaults (select Load Optimized Defaults) or manually configure the BIOS settings (please navigate to the "BIOS Setup" page of GIGABYTE's website for more information).

15) BAT (Battery)

The battery provides power to keep the values (such as BIOS configurations, date, and time information) in the CMOS when the computer is turned off. Replace the battery when the battery voltage drops to a low level, or the CMOS values may not be accurate or may be lost.





You may clear the CMOS values by removing the battery:

- 1. Turn off your computer and unplug the power cord.
- Gently remove the battery from the battery holder and wait for one minute. (Or use a metal object like a screwdriver to touch the positive and negative terminals of the battery holder, making them short for 5 seconds.)
- 3. Replace the battery.
- 4. Plug in the power cord and restart your computer.



- Always turn off your computer and unplug the power cord before replacing the battery.
- Replace the battery with an equivalent one. Damage to your devices may occur if the battery is replaced with an incorrect model.
- Contact the place of purchase or local dealer if you are not able to replace the battery by yourself
 or uncertain about the battery model.
- When installing the battery, note the orientation of the positive side (+) and the negative side (-)
 of the battery (the positive side should face up).
- Used batteries must be handled in accordance with local environmental regulations.

Chapter 3 BIOS Setup

BIOS (Basic Input and Output System) records hardware parameters of the system in the CMOS on the motherboard. Its major functions include conducting the Power-On Self-Test (POST) during system startup, saving system parameters and loading operating system, etc. BIOS includes a BIOS Setup program that allows the user to modify basic system configuration settings or to activate certain system features.

When the power is turned off, the battery on the motherboard supplies the necessary power to the CMOS to keep the configuration values in the CMOS.

To access the BIOS Setup program, press the <Delete> key during the POST when the power is turned on.

- To upgrade the BIOS, use either the GIGABYTE Q-Flash or @BIOS utility.
- Q-Flash allows the user to quickly and easily upgrade or back up BIOS without entering the operating system.
- @BIOS is a Windows-based utility that searches and downloads the latest version of BIOS from the Internet and updates the BIOS.

For instructions on using the Q-Flash and @BIOS utilities, please navigate to the "Unique Features" page of GIGABYTE's website and search for "BIOS Update Utilities."



- Because BIOS flashing is potentially risky, if you do not encounter problems using the current version of BIOS, it is recommended that you not flash the BIOS. To flash the BIOS, do it with caution. Inadequate BIOS flashing may result in system malfunction.
- It is recommended that you not alter the default settings (unless you need to) to prevent system
 instability or other unexpected results. Inadequately altering the settings may result in system's
 failure to boot. If this occurs, try to clear the CMOS values and reset the board to default values.
- Refer to the introductions of the battery/clear CMOS jumper in Chapter 2 or navigate to the "BIOS Setup" page of GIGABYTE's website and search for "Load Optimized Defaults" for how to clear the CMOS values.
- The BIOS Setup menus are for reference only and may differ by BIOS version.

Please visit GIGABYTE's website for details on configuring BIOS Setup. https://www.gigabyte.com/WebPage/941/intel400-bios.html

Startup Screen:

The following startup Logo screen will appear when the computer boots.



Function Keys:

: BIOS SETUP\Q-FLASH

Press the <Delete> key to enter BIOS Setup or to access the Q-Flash utility in BIOS Setup.

<F12>: BOOT MENU

Boot Menu allows you to set the first boot device without entering BIOS Setup. In Boot Menu, use the up arrow key <1> or the down arrow key <1> to select the first boot device, then press <Enter> to accept. The system will boot from the device immediately.

Note: The setting in Boot Menu is effective for one time only. After system restart, the device boot order will still be based on BIOS Setup settings.

<END>: Q-FLASH

Press the <End> key to access the Q-Flash utility directly without having to enter BIOS Setup first.

Chapter 4 Installing the Operating System and Drivers

4-1 Operating System Installation

With the correct BIOS settings, you are ready to install the operating system.

As some operating systems already include RAID driver, you do not need to install separate RAID driver during the Windows installation process. After the operating system is installed, we recommend that you install all required drivers from the GIGABYTE APP Center to ensure system performance and compatibility. If the operating system to be installed requires that you provide additional RAID driver during the OS installation process, please refer to the steps below:

Step 1:

Go to GIGABYTE's website, browse to the motherboard model's web page, download the Intel SATA Preinstall driver file on the Support\Download\SATA RAID/AHCI page, unzip the file and copy the files to your USB thumb drive.

Step 2:

Boot from the Windows setup disc and perform standard OS installation steps. When the screen requesting you to load the driver appears, select **Browse**.

Step 3:

Insert the USB thumb drive and then browse to the location of the driver. When a screen as shown below appears, select Intel RST VMD Controller 467F and click Next to load the driver and continue the OS installation.

Intel RST V	/MD Controller 48	67F (D:\IRST\VMD\	(f6vmdflpy-x64∖ia	StorVD.inf)	

4-2 Drivers Installation

After you install the operating system, a dialog box will appear on the bottom-right corner of the desktop asking if you want to download and install the drivers and GIGABYTE applications via APP Center. Click Install to proceed with the installation. (In BIOS Setup, make sure Settings\IO Ports\APP Center Download & Install Configuration\APP Center Download & Install is set to Enabled.)



When the End User License Agreement dialog box appears, press <Accept> to install APP Center. On the APP Center screen, select the drivers and applications you want to install and click **Install**.

		🕈 Update	▲ Not Installed 10		
		from Microsoft Windo	ows Update(requires internet connection)		
New D					
New U	©BIOS				
@	Size: 33.7 MB Version: B20.0709.1		to update the system BIOS while in the Windows environment. @BIOS e latest BIOS file from the nearest @BIOS server site and update the BIOS.		
C	EasyTune Size: 12.63 MB Version: B21.0114.1		une is a simple and easy-to-use interface that allows users to fine-tune ings or do overclock/overvoltage in Windows environment.		
EasyTuneEngineService					
0	Size: 29.12 MB Version: B21.0202.1		une is a simple and easy-to-use interface that allows users to fine-tune ings or do overclock/overvoltage in Windows environment.		
Ż	OnOffCharge2 Size: 5.92 MB Version: 815.0709.1		F Charge2 Technology can automatically detect your mobile device such nd tablet PC and quickly charge the device through USB interface. It charging solution while the system is turned on, in sleep/standby mode, f,		
√ }	Size: 13.08 MB Version: B21.0129.1	CPU, Memory, Volt	Information Viewer (SIV) provides useful hardware information such as tage status in your desktop. It also allows user to monitor and adjust all ation mode in order to either reduce fan noise (low rpm) or increase e. (high rpm)		
	SmartBackup				
	Size: 44.96 MB Version: B21.0326.1		ows you to back up a partition as an image file every hour. You can use estore your system or files when needed.		

Before the installation, make sure the system is connected to the Internet.

- Please visit GIGABYTE's website for more software information. https://www.gigabyte.com/WebPage/498/h470-app.html
- Please visit GIGABYTE's website for more troubleshooting information. https://www.gigabyte.com/WebPage/351/faq.html

Chapter 5 Appendix

5-1 Configuring a RAID Set

RAID Levels

	RAID 0	RAID 1	RAID 5	RAID 10
Minimum Number of Hard Drives	≥2	2	≥3	4
Array Capacity	Number of hard drives * Size of the smallest drive	Size of the smallest drive	(Number of hard drives -1) * Size of the smallest drive	(Number of hard drives/2) * Size of the smallest drive
Fault Tolerance	No	Yes	Yes	Yes

Before you begin, please prepare the following items:

This motherboard supports RAID 0, RAID 1, RAID 5, and RAID 10. Prepare the correct number of hard drives as indicated in the table above before configuring a RAID array.

- SATA hard drives or SSDs. To ensure optimal performance, it is recommended that you use two hard drives
 with identical model and capacity.
- Windows setup disc.
- An Internet connected computer.
- A USB thumb drive.

Please note that an M.2 PCIe SSD cannot be used to create a RAID set with a SATA hard drive.

Please visit GIGABYTE's website for details on configuring a RAID array. https://www.gigabyte.com/WebPage/499/h470-raid.html

Regulatory Notices

United States of America, Federal Communications Commission Statement



Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with manufacturer's instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receive
- Connect the equipment to an outlet on a circuit different from that to which the receiver is connected
- Consult the dealer or an experienced radio/TV technician for help

Canadian Department of Communications Statement

This digital apparatus does not exceed the Class B limits for radio noise emissions from digital apparatus set out in the Radio Interference Regulations of the Canadian Department of Communications. This class B digital apparatus complies with Canadian ICES-003

Avis de conformité à la réglementation d'Industrie Canada

Cet appareil numérique de la classe B est conforme à la norme NMB-003 du Canada. European Union (EU) CE Declaration of Conformity

European Union (EU) CE Declaration of Committy This device complies with the following directives: Electromagnetic Compatibility Directive 2014/30/EU, Low-voltage Directive 2014/35/EU, RoHS directive (recast) 2011/65/EU & the 2015/863 Statement. This product has been tested and found to comply with all essential requirements of the Directives.

European Union (EU) RoHS (recast) Directive 2011/65/EU & the European Commission Delegated Directive (EU) 2015/863 Statement

GIGABYTE products have not intended to add and safe from hazardous substances (Cd, Pb, Hg, Cr+6, PBDE, PBB, DEHP, BBP, DBP and DIBP). The parts and components have been carefully selected to meet RoHS requirement. Moreover, we at GIGABYTE are continuing our efforts to develop products that do not use internationally banned toxic chemicals.

European Union (EU) Community Waste Electrical & Electronic Equipment (WEEE) Directive Statement

GIGABYTE will fulfill the national laws as interpreted from the 2012/19/EU WEEE (Waste Electrical and Electronic Equipment) (recast) directive. The WEEE Directive specifies the treatment, collection, recycling and disposal of electric and electronic devices and their components. Under the Directive, used equipment must be marked, collected separately, and disposed of properly.

WEEE Symbol Statement



The symbol shown below is on the product or on its packaging, which indicates that this product must not be disposed of with other waste Instead, the device should be taken to the waste collection centers for activation of the treatment, collection, recycling and disposal procedure.

For more information about where you can drop off your waste equipment for recycling, please contact your local government office, your household waste disposal service or where you purchased the product for details of environmentally safe recycling.

Battery Information

European Union—Disposal and recycling information GIGABYTE Recycling Program (available in some regions)



This symbol indicates that this product and/or battery should not be disposed of with household waste. You must use the public collection system to return, recycle, or treat them in compliance with the local regulations

End of Life Directives-Recycling



The symbol shown below is on the product or on its packaging, which indicates that this product must not be disposed of with other waste. Instead, the device should be taken to the waste collection centers for activation of the treatment, collection, recycling and disposal procedure.

Déclaration de Conformité aux Directives de l'Union européenne (UE)

Cet appareil portant la marque CE est conforme aux directives de l'UE suivantes: directive Compatibilité Electromagnétique 2014/30/UE, directive Basse Tension 2014/35/UE et directive RoHS II 2011/65/UE. La conformité à ces directives est évaluée sur la base des normes européennes harmonisées applicables

European Union (EU) CE-Konformitätserklärung Dieses Produkte mit CE-Kennzeichnung erfüllen folgenden EU-Richtlinien: EMV-Richtlinie 2014/30/EU, Niederspannungsrichtlinie 2014/30/EU und RoHS-Richtlinie 2014/30/EU ind RoHS-Richtlinie 2011/65/EU erfüllt. Die Konformität mit diesen Richtlinien wird unter Verwendung der prechenden Standards zurEuropäischen Normierung beurteilt.

CE declaração de conformidade

Este produto com a marcação CE estão em conformidade com das seguintes Diretivas UE: Diretiva Baixa Tensão 2014/35/EU: Diretiva CEM 2014/30/EU: Diretiva RSP 2011/65/UE. A conformidade com estas diretivas é verificada utilizando as normas europeias harmonizadas

CE Declaración de conformidad

Este producto que llevan la marca CE cumplen con las siguientes Directivas de la Unión Europea: Directiva EMC (2014/30/EU), Directiva de bajo voltaje (2014/35/EU), Directiva RoHS (recast) (2011/65/EU). El cumplimiento de estas directivas se evalúa mediante las normas europeas armonizadas.

Dichiarazione di conformità CE

Questo prodotto è conforme alle seguenti direttive: Direttiva sulla compatibilità elettromagnetica 2014/30/UE, Direttiva sulla bassa tensione 2014/35/UE, Direttiva RoHS (rifusione) 2011/65/UE. Questo prodotto è stato testato e trovato conforme a tutti i requisiti essenziali delle Direttive



RoHS

WARNING

- INGESTION HAZARD: This product contains a button cell or coin hatt
- DEATH or serious injury can occur if indested
- ved button cell or coin battery can cause Internal
- Chemical Burns in as little as 2 hours KEEP new and used batteries OUT OF REACH of CHILDREN
- Seek immediate medical attention if a battery is suspected to be swallowed or inserted inside any part of the body.
- Battery type: CR2032, voltage rating: +3VDC.
- Non-rechargeable batteries are not to be recharged.
- Remove and immediately recycle or dispose of used batteries, batteries from equipment not used for an extended period of time according to local regulations and keep away from children. Do NOT dispose of batteries in household trash or incinerate
- Even used batteries may cause severe injury or death.
- Do not force discharge, recharge, disassemble, heat above (manufacturer's specified temperature rating) or incinerate. Doing so may result in injury due to venting, leakage or explosion resulting in chemical burns.
- For treatment information, call a local poison control center
- The product contains non-replaceable batteries



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GIGABYTE eSupport

To submit a technical or non-technical (Sales/Marketing) question, please link to: https://esupport.gigabyte.com

